ShinDengen

P32B12SN

Power MOSFETs
120V, 32A, N-channel

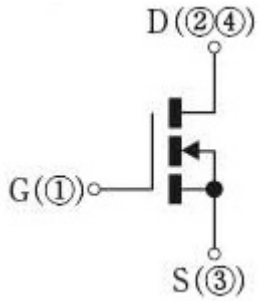
Feature

- N-channel
- SMD
- Low Ron
- 10V Gate Drive
- Low Capacitance
- Pb free terminal
- RoHS:Yes

OUTLINE

Package (House Name): FB
Package (JEDEC Code): TO-252AA

Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified : Tc=25℃)

Item	Symbol	Conditions	Ratings	Unit
Storage temperature	Tstg		-55 to 150	℃
Channel tempertature	Tch		-55 to 150	℃
Drain-source voltage	V_{DSS}		120	V
Gate-source voltage	V_{GSS}		±20	V
Continuous drain current(DC)	I_D		32	A
Continuous drain current(Peak)	I_{DP}	Pulse width 10μs, duty=1/100	96	A
Total power dissipation	P_T		62.5	W
Single avalanche current	I_{AS}	Starting Tch=25℃ Tch≦150℃	25	A
Single avalanche energy	E_{AS}	Starting Tch=25℃ Tch≦150℃	71	mJ

※ :See the original Specifications

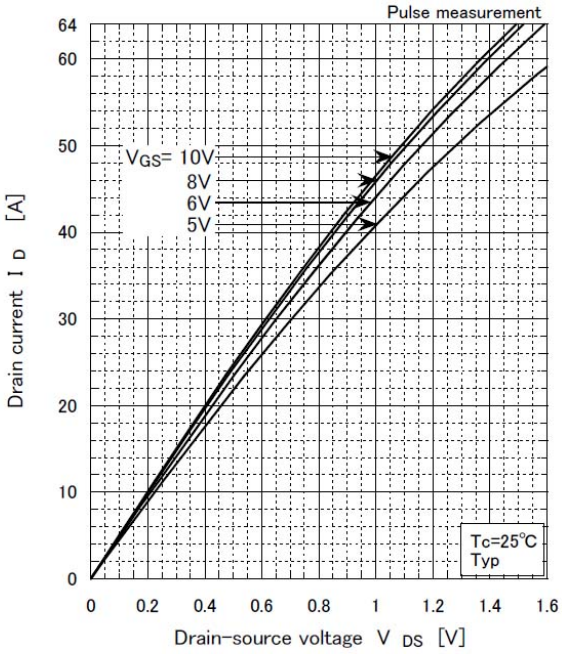
Electrical Characteristics (unless otherwise specified : Tc=25℃)

Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Drain-Source breakdown voltage	$V_{(BR)DSS}$	ID=1mA, VGS=0V	120			V
Zero gate voltage drain current	I_{DSS}	VDS=120V, VGS=0V			1	μA
Gate-source leakage current	I_{GSS}	VGS=±20V, VDS=0V			±0.1	μA
Forward transconductance	g_{fs}	ID=16A, VDS=10V	11.5	23		S
Static drain-source on-state resistance	$R_{DS(ON)}$	ID=16A, VGS=10V		0.02	0.025	Ω
Gate threshold voltage	Vth	ID=1mA, VDS=10V	2	3	4	V
Source-drain diode forward voltage	V_{SD}	IS=32A, VGS=0V			1.5	V
Thermal resistance	Rth(j-c)	Junction to case, with heatsink ※			2	℃/W
Total gate charge	Qg	VDD=96V, VGS=10V, ID=32A		57		nC
Gate to source charge	Qgs	VDD=96V, VGS=10V, ID=32A		14.5		nC
Gate to drain charge	Qgd	VDD=96V, VGS=10V, ID=32A		19		nC
Input capacitance	Ciss	VDS=25V, VGS=0V, f=1MHz		2915		pF
Reverce transfer capacitnce	Crss	VDS=25V, VGS=0V, f=1MHz		110		pF
Output capacitance	Coss	VDS=25V, VGS=0V, f=1MHz		228		pF
Turn-on delay time	td(on)	ID=16A, RL=3.75Ω, VDD=60V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		6.5		ns
Rise time	tr	ID=16A, RL=3.75Ω, VDD=60V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		17		ns
Turn-off delay time	td(off)	ID=16A, RL=3.75Ω, VDD=60V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		31		ns
Fall time	tf	ID=16A, RL=3.75Ω, VDD=60V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		16		ns
Diode reverse recovery time	trr	IF=32A, VGS=0V, di/dt=100A/μs		61		ns
Diode reverse recovery charge	Qrr	IF=32A, VGS=0V, di/dt=100A/μs		140		nC

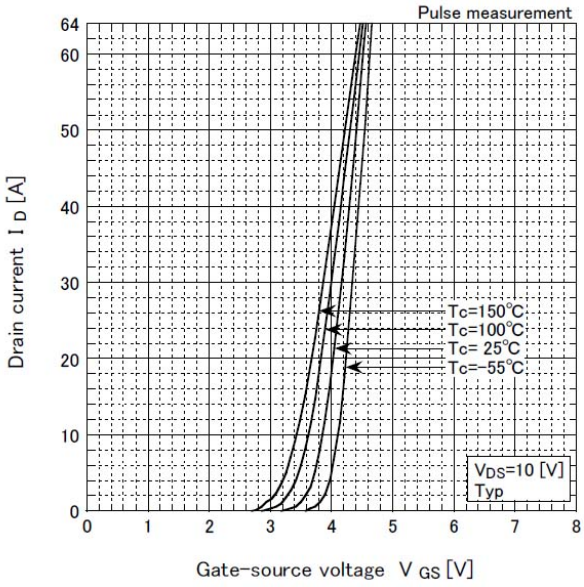
※ ：See the original Specifications

CHARACTERISTIC DIAGRAMS

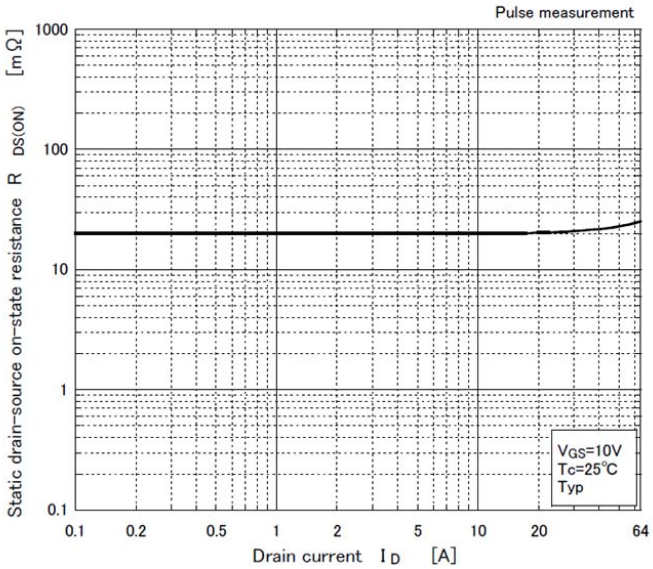
Typical output characteristics



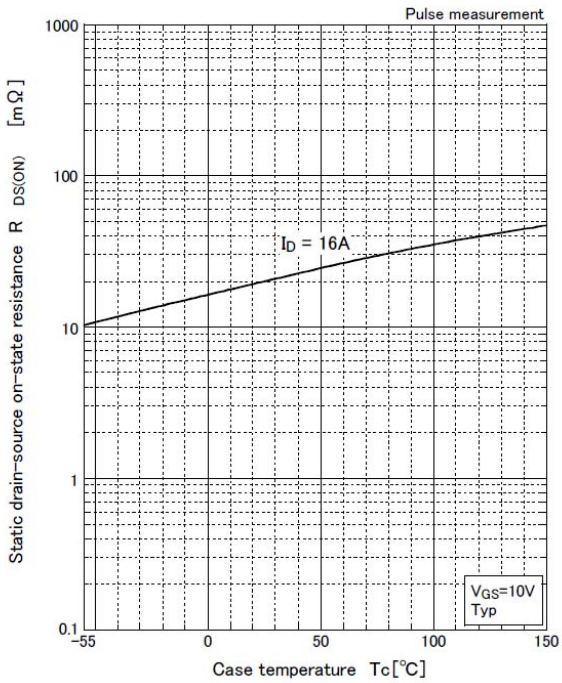
Transfer characteristics



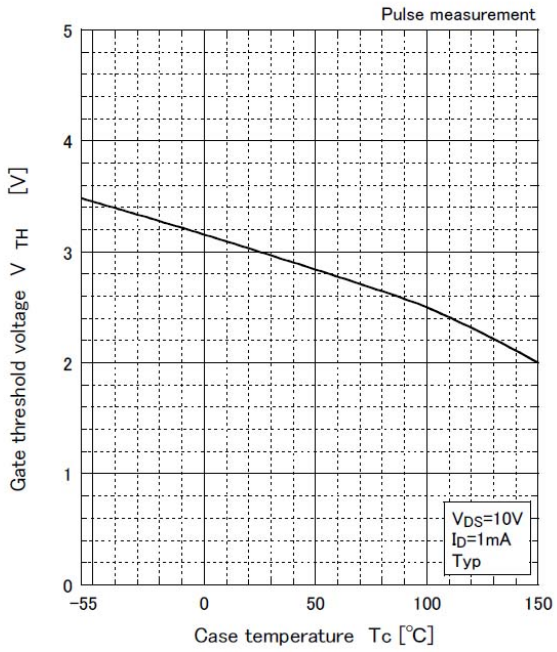
Static drain-source on-state resistance
vs drain current



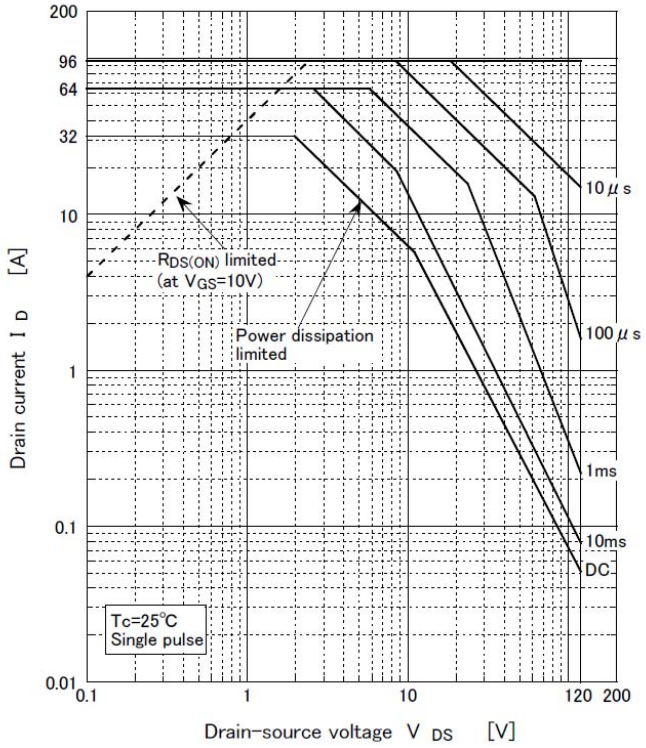
Static drain-source on-state resistance
vs case temperature

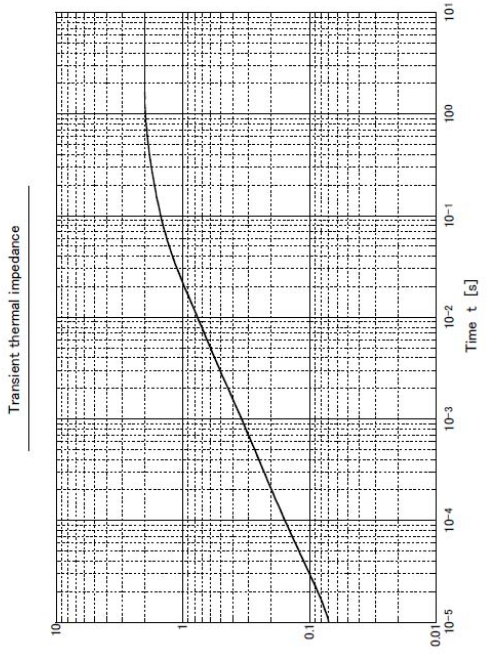


Gate threshold voltage
vs case temperature



Safe operating area

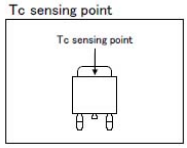




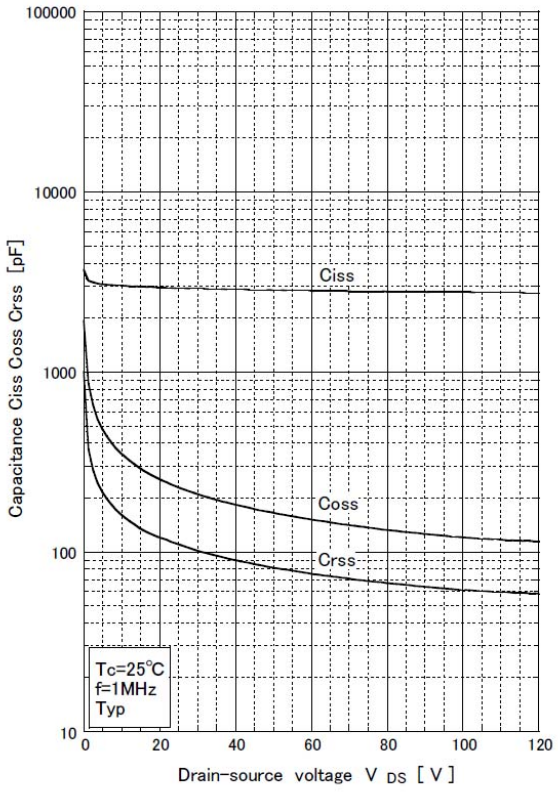
Substrate detail

Type	Alumina
Size	1 inch²
Thickness	0.64mm
Conductor thickness	20μm
Pattern area	65mm²

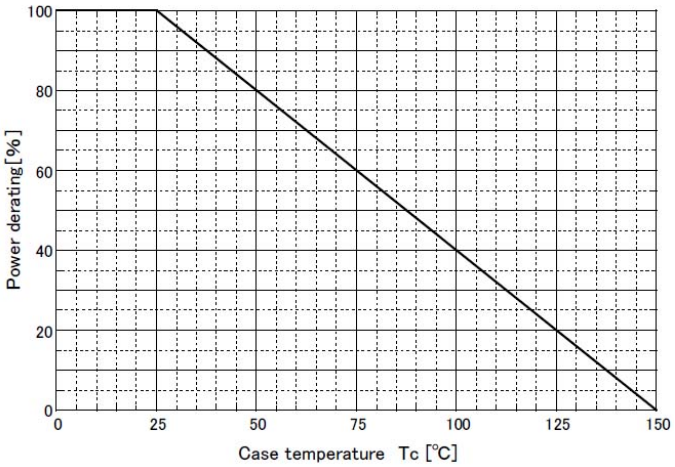
Tc sensing point



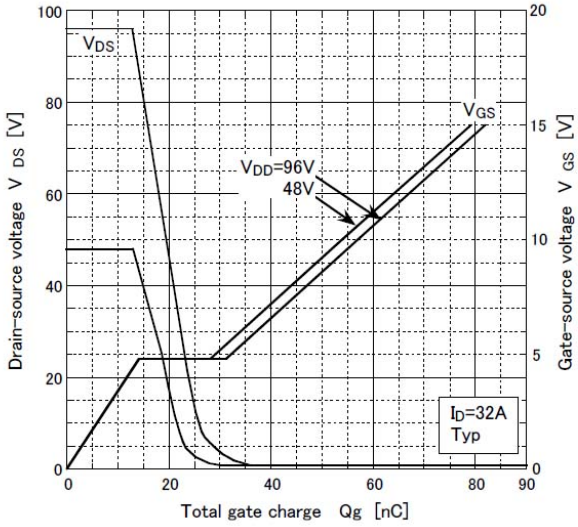
Capacitance characteristics



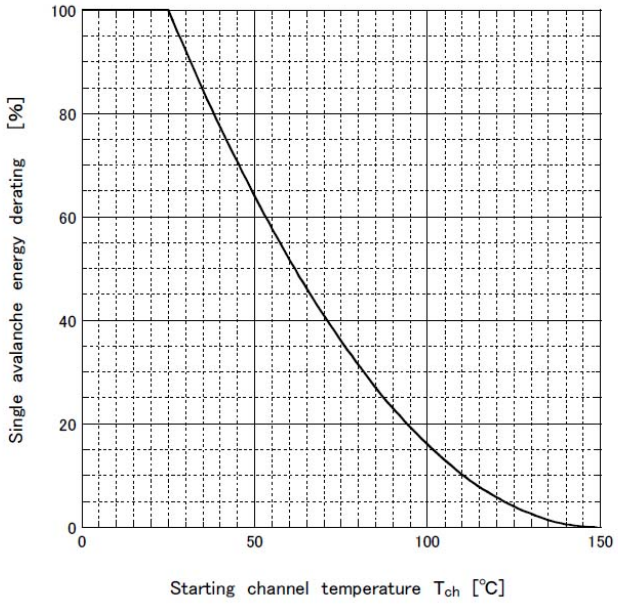
Power derating – case temperature



Gate charge characteristics



Single avalanche energy derating
vs channel temperature

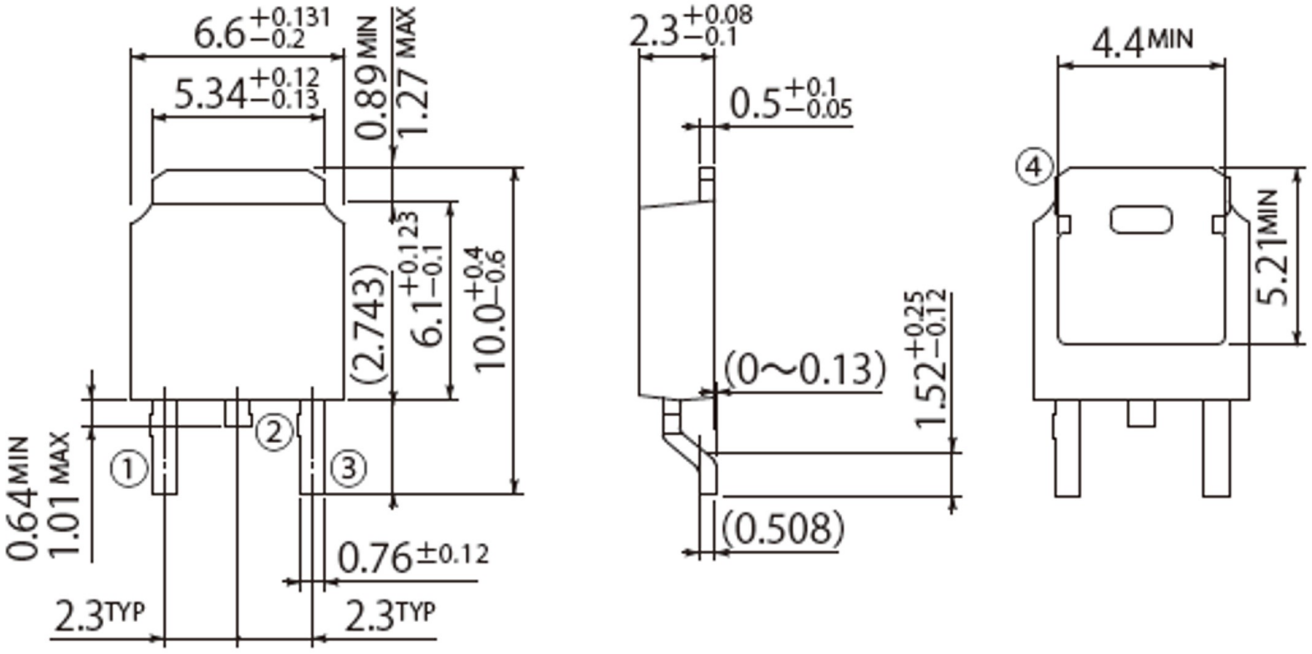


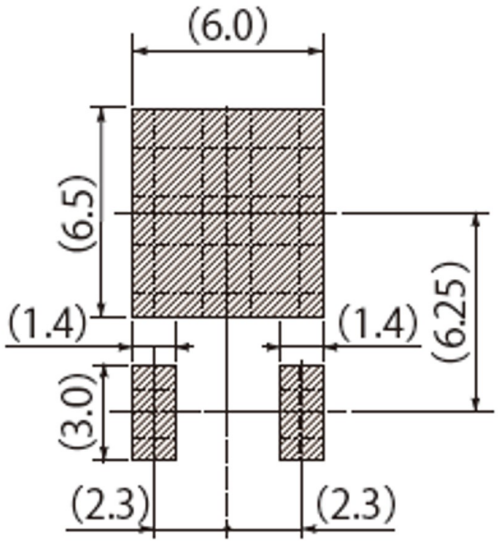
Outline Dimensions

unit:mm

G2

JEDEC Code	TO-252AA
JEITA Code	–
House Name	FB





Referential Soldering Pad

Notes

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